

1156893

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SMD socket, nominal current: 3 A, test voltage: 500 V AC, number of positions: 80, pitch: 2.54 mm, color: black, contact surface: Au, contact connection type: Socket, mounting: SMD soldering



### Your advantages

- · Reliable mechanical and electrical connections thanks to the double-sided contact system
- · Designed for integration into the SMT soldering process
- · Clear and cost-optimized design
- · Suitable for a multitude of applications
- · Stacked, coplanar or orthogonal PCB connections enable maximum flexibility in the device

### Commercial data

Item number	1156893
Packing unit	40 pc
Minimum order quantity	40 pc
Sales key	AA24
Product key	AAXABB
GTIN	4063151159870
Weight per piece (including packing)	11.94 g
Weight per piece (excluding packing)	11 g
Customs tariff number	85366930
Country of origin	CN



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### Technical data

### Notes

Notes on operation	The permissible voltage during operation depends on the application, taking into consideration the air clearances and
	creepage distances within the scope of insulation requirements in accordance with IEC 60664-1.
	accordance with IEC 00004-1.

### Product properties

Product type	SMD socket
Product family	FQ 2,54D/SV
Number of positions	80
Pitch	2.54 mm
Number of rows	2
Pin layout	Linear pad geometry

### Electrical properties

### Properties

•	
Nominal current I <sub>N</sub>	3 A (at 20°C 80-pos.)
Contact resistance	20 mΩ
Test voltage	500 V AC IEC 60512-4-1:2003-05

### **Dimensions**

Dimensional drawing	h
Pitch	2.54 mm
Width [w]	102 mm
Height [h]	11.2 mm
Length [I]	7.9 mm
Installed height	9.8 mm
Application	
Contact cover	0.4 mm
Stack height	13.6 mm Tolerance: +1.3 mm (in combination with Range of articles:FQ 2,54D/PV)
Wipe length	1.3 mm
PCB design	
Pad geometry	1.04 x 3.38 mm

### Material specifications



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#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Selective coating
Metal surface contact area (top layer)	Gold (Au)
Metal surface contact area (middle layer)	Nickel (Ni)
Metal surface soldering area (top layer)	Tin (Sn)

### Material data - housing

Color (Housing)	black (9005)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0

### Connector

### Connection 1

Insulating material	PA
CTI according to IEC 60112	600

### Electrical tests

### Thermal test | Test group C

Specification	IEC 60512-5-2:2002-02
Tested number of positions	80
Insulation resistance	
Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 1 GΩ
Air clearances and creepage distances	

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Insulating material group	I
Minimum value for clearance and creepage distance	0.4 mm

### Mechanical tests

### Insertion and withdrawal forces

Result	Test passed
No. of cycles	100
Insertion strength per pos. approx.	2.9 N
Withdraw strength per pos. approx.	2.9 N

### Visual inspection

Visual inspection	
Specification	IEC 60512-1-1:2002-02
Result	Test passed



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Specification	IEC 60512-1-2:2002-02
Result	Test passed

### Environmental and real-life conditions

#### Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 55 - 10 Hz
Sweep speed	1 octave/min
Amplitude	1.52 mm
Acceleration	181 m/s²
Test duration per axis	2 h
Test directions	X-, Y- and Z-axis

### **Durability test**

Specification	IEC 60512-9-1:2010-03 (following)
Contact resistance R <sub>1</sub>	20 mΩ
Contact resistance R <sub>2</sub>	30 mΩ
Insertion/withdrawal cycles	100
Insulation resistance, neighboring positions	> 1 GΩ

### Ambient conditions

Ambient temperature (operation)	-40 °C 125 °C
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C

### Mounting

Mounting type SMD sol	ldering
Pin layout Linear p	ad geometry

### Processing notes

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T <sub>c</sub>	260 °C

### Packaging specifications

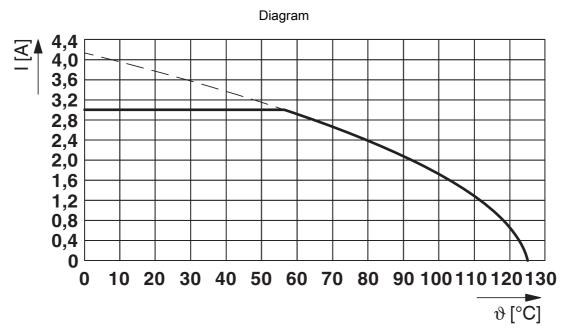
Type of packaging	Tube magazine



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## Drawings



Type: FQ 2,54D/...-SV-1020-1-BT with FQ 2,54D/...-PV- 380-1-BT



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## **Approvals**

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1156893

c <b>711</b> vs	cULus Recognized Approval ID: E118976				
		Nominal voltage U <sub>N</sub>	Nominal current I <sub>N</sub>	Cross section AWG	Cross section mm <sup>2</sup>
keine					
		30 V	3 A	-	-



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## Classifications

### **ECLASS**

	ECLASS-13.0	27460201			
	ECLASS-15.0	27460201			
ΕΊ	ETIM				
	ETIM 9.0	EC002637			
UNSPSC					
	UNSPSC 21.0	39121400			



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## Environmental product compliance

#### EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions		
China RoHS			
Environment friendly use period (EFUP)	EFUP-E		
	No hazardous substances above the limits		
EU REACH SVHC			
REACH candidate substance (CAS No.)	No substance above 0.1 wt%		

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Phoenix Contact USA 586 Fulling Mill Road Middletown, PA 17057, United States (+717) 944-1300 info@phoenixcon.com